Microfabricated Gas Sensors Based on Hydrothermally Grown 1-D ZnO Nanostructures

MINGZHI JIAO
In this thesis, gas sensors based on on-chip hydrothermally grown 1-D zinc oxide (ZnO) nanostructures are presented, to improve the sensitivity, selectivity, and stability of the gas sensors.

Metal-oxide-semiconductor (MOS) gas sensors are well-established tools for the monitoring of air quality indoors and outdoors. In recent years, the use of 1-D metal oxide nanostructures for sensing toxic gases, such as nitrogen dioxide, ammonia, and hydrogen, has gained significant attention. However, low-dimensional nanorod (NR) gas sensors can be enhanced further. Most works synthesize the NRs first and then transfer them onto electrodes to produce gas sensors, thereby resulting in large batch-to-batch difference.

Therefore, in this thesis six studies on 1-D ZnO NR gas sensors were carried out. First, ultrathin secondary ZnO nanowires (NWs) were successfully grown on a silicon substrate. Second, an on-chip hydrothermally grown ZnO NR gas sensor was developed on a glass substrate. Its performance with regard to sensing nitrogen dioxide and three reductive gases, namely, ethanol, hydrogen, and ammonia, was tested. Third, three 1-D ZnO nanostructures, namely, ZnO NRs, dense ZnO NWs, and sparse ZnO NWs, were synthesized and tested toward nitrogen dioxide. Fourth, hydrothermally grown ZnO NRs, chemical vapor deposited ZnO NWs, and thermal deposited ZnO nanoparticles (NPs) were tested toward ethanol. Fifth, the effect of annealing on the sensitivity and stability of ZnO NR gas sensors was examined. Sixth, ZnO NRs were decorated with palladium oxide NPs and tested toward hydrogen at high temperature.

The following conclusions can be drawn from the work in this thesis: 1) ZnO NWs can be obtained by using a precursor at low concentration, temperature of 90 °C, and long reaction time. 2) ZnO NR gas sensors have better selectivity to nitrogen dioxide compared with ethanol, ammonia, and hydrogen. 3) Sparse ZnO NWs are highly sensitive to nitrogen dioxide compared with dense ZnO NWs and ZnO NRs. 4) ZnO NPs have the highest sensitivity to ethanol compared with dense ZnO NWs and ZnO NRs. The sensitivity of the NPs is due to their small grain sizes and large surface areas. 5) ZnO NRs annealed at 600 °C have lower sensitivity toward nitrogen dioxide but higher long-term stability compared with those annealed at 400 °C. 6) When decorated with palladium oxide, both materials form alloy at a temperature higher than 350 °C and decrease the amount of ZnO, which is the sensing material toward hydrogen. Thus, controlling the amount of palladium oxide on ZnO NRs is necessary.

Keywords: gas sensor, zinc oxide, on-chip, hydrothermal growth, nanorods, nanowires, annealing, palladium oxide, photoluminescence, alloy, sensitivity, selectivity, stability

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To my family and all my friends
List of Papers

This thesis is based on the following papers, which are referred to in the text by their Roman numerals.


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Author’s contribution

**Paper I** Part of planning, major part of experimental and analysis, part of writing.

**Paper II** Part of planning; major part of experimental, analysis, and writing.

**Paper III** Part of planning; major part of experimental, analysis, and writing.

**Paper IV** Part of experimental.

**Paper V** Minor part of planning, part of experimental, all analysis, and major part of writing.

**Paper VI** Major part of planning, experimental, analysis, and writing.
### Abbreviations

<table>
<thead>
<tr>
<th>Abbreviation</th>
<th>Description</th>
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<tbody>
<tr>
<td>1-D</td>
<td>One dimensional</td>
</tr>
<tr>
<td>NR</td>
<td>Nanorod</td>
</tr>
<tr>
<td>NW</td>
<td>Nanowire</td>
</tr>
<tr>
<td>NP</td>
<td>Nanoparticle</td>
</tr>
<tr>
<td>MOS</td>
<td>Metal oxide semiconductor</td>
</tr>
<tr>
<td>CVD</td>
<td>Chemical vapor deposition</td>
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<tr>
<td>PVD</td>
<td>Physical vapor deposition</td>
</tr>
<tr>
<td>PL</td>
<td>Photoluminescence</td>
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<tr>
<td>SEM</td>
<td>Scanning Electron Microscopy</td>
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<tr>
<td>TEM</td>
<td>Transmission Electron Microscopy</td>
</tr>
<tr>
<td>XRD</td>
<td>X-ray diffraction</td>
</tr>
<tr>
<td>XPS</td>
<td>X-ray photoelectron spectroscopy</td>
</tr>
<tr>
<td>EDS</td>
<td>Energy-dispersive X-ray spectroscopy</td>
</tr>
<tr>
<td>HMTA</td>
<td>Hexamethylenetetramine</td>
</tr>
<tr>
<td>$L_D$</td>
<td>Debye length</td>
</tr>
<tr>
<td>$V_{\text{surface}}$</td>
<td>Surface potential</td>
</tr>
<tr>
<td>$k_B$</td>
<td>Boltzmann constant, $1.38 \times 10^{-23}$ J/K</td>
</tr>
<tr>
<td>$\varepsilon_0$</td>
<td>the dielectric constant of vacuum, $8.85 \times 10^{-12}$ F/m</td>
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1. Introduction

1.1 Markets and types of gas sensors

Gas sensors were invented because of the strong necessity to measure gas components in living environments. As early as 1941, a humidity control apparatus was patented to measure and control humidity in a closed space [1]. Apart from water vapor, many other gases are present in air. Some of these gases can be harmful to humans. Nitrogen dioxide and hydrogen sulfide have strong odors and thus can be detected by human nose. By contrast, hydrogen and carbon dioxide are odorless and thus cannot be detected. Therefore, gas sensors must be used to detect and determine the concentration of carbon dioxide and nitrogen dioxide in the air. Today, gas sensors can be found indoors and outdoors. Gas sensors have been applied in environmental monitoring, industrial control, home security, and even in agriculture. Nowadays, the Internet of Things can facilitate our life, and gas sensors are one of the key components in the area. The typical applications of gas sensors and their typical measured gases can be divided, as follows [2]:

- Food and agriculture (humidity, CO₂)
- Automotive (O₂, CO, NOₓ, SOₓ)
- Health and breath analysis (NH₃, C₂H₅OH)
- Environment (CO, CO₂, NOₓ, H₂S)
- Industry (O₂, H₂, CO, H₂S)

The market for gas sensors in Europe is growing, as shown in Figure 1 [3]. The gas sensor market is estimated to increase to approximately 750 million USD in 2020. Owing to the huge market for gas sensors and specific demand for gas sensors in different fields, research on gas sensors continues to progress despite their long history.
Gas sensors can be categorized according to target gases, as shown in the figure above. They can also be categorized according to types, on which their working principles are based, as shown in Table 1 [4].

Table 1. Types and mechanisms of common gas sensors. Courtesy of Alphus D. Wilson.

<table>
<thead>
<tr>
<th>Sensor type</th>
<th>Sensitive material</th>
<th>Detection principle</th>
</tr>
</thead>
<tbody>
<tr>
<td>Acoustic: Quartz crystal microbalance, surface and bulk acoustic wave</td>
<td>Organic or inorganic film</td>
<td>Mass change (frequency shift)</td>
</tr>
<tr>
<td>Calorimetric: catalytic bead</td>
<td>Pellistor</td>
<td>Temperature or heat change</td>
</tr>
<tr>
<td>Catalytic field-effect transistor</td>
<td>Catalytic metals</td>
<td>Electrical field change</td>
</tr>
<tr>
<td>Colorimetric sensors</td>
<td>Organic dyes</td>
<td>Color changes, absorbance</td>
</tr>
<tr>
<td>Conducting polymer sensors</td>
<td>Modified conducting polymer</td>
<td>Resistance</td>
</tr>
<tr>
<td>Electrochemical sensors</td>
<td>Solid or liquid electrolytes</td>
<td>Current or voltage change</td>
</tr>
<tr>
<td>Fluorescence sensors</td>
<td>Fluorescence-sensitive detector</td>
<td>Fluorescent-light emission</td>
</tr>
<tr>
<td>Infrared sensors</td>
<td>IR-sensitive detector</td>
<td>Infrared-radiation adsorption</td>
</tr>
<tr>
<td>Metal oxide semiconductor sensors</td>
<td>Semiconductor metal oxide</td>
<td>Resistance change</td>
</tr>
<tr>
<td>Optical sensors</td>
<td>Photodiode</td>
<td>Light modulation, optical changes</td>
</tr>
</tbody>
</table>

Gas sensors are evaluated mainly according to a number of parameters, which are listed and explained below [5].

- Response is the ratio between measured resistance in target gas and a reference resistance or the other way round. The reference resistance normally is the sensor resistance measured in dry air. Response is usually larger than 1.
- Sensitivity is the ratio between resistance change per target gas concentration unit, in other words, the slope of a measurement graph. Some researchers also use the physical definition of sensitivity, that is, the ratio between a resistance change and the reference resistance.
- Selectivity reflects how well a sensor can respond to a single target gas in a mixture containing another gas, that is, selectivity is the ratio between the responses of two gases.
- Stability is the ability of a sensor to provide the same results. Therefore, the sensitivity, selectivity, response, and recovery time of the sensor remains unchanged.
- Response time ($t_R$) is the time a sensor needs to respond to a target gas after the gas concentration changes from zero to a certain value.
- Recovery time is the time required for the sensor signal to return to its starting point after the target gas concentration has dropped to zero.
- Size and cost
- Power consumption
- Operation temperature ($T_{OPE}$)

A gas sensor is selected on the basis of specific application requirements, such as working temperature range, sensitivity, and selectivity. The selection of a sensor should also be based on the advantages and disadvantages of a specific sensor. For example, electrochemical gas sensors can work at ambient temperature and require low power. However, their sensitivity to low-weight gas is low. Optical gas sensors have high sensitivity and selectivity. However, they are expensive and often not portable. The advantages and disadvantages of the most commonly used gas sensors are shown in Table 2 [4]:

Table 2. Pros and cons of some most commonly used gas sensor types. Courtesy of Alphas D. Wilson.

<table>
<thead>
<tr>
<th>Sensor type</th>
<th>Pros</th>
<th>Cons</th>
</tr>
</thead>
<tbody>
<tr>
<td>Calorimetric</td>
<td>High selectivity for oxidative compounds, short $t_R$</td>
<td>High $T_{OPE}$, only sensitive to oxidative compounds</td>
</tr>
<tr>
<td>Catalytic field-effect transistor</td>
<td>Stability, wide $T_{OPE}$ range, small size</td>
<td>Requires environmental control, baseline drift</td>
</tr>
<tr>
<td>Electrochemical</td>
<td>Ambient $T_{OPE}$, low power, sensitive to diverse VOCs</td>
<td>Bulky size, limited sensitivity to low weight gas</td>
</tr>
<tr>
<td>Metal oxide semiconductor</td>
<td>High sensitivity, limited sensing range, short $t_R$ for low weight gas</td>
<td>High $T_{OPE}$, high power, sensitive to humidity</td>
</tr>
<tr>
<td>Optical</td>
<td>High sensitivity and selectivity</td>
<td>Expensive, low portability, complex sensor array system</td>
</tr>
</tbody>
</table>
1.2 MOS Gas sensors

Among all types of gas sensors, the MOS gas sensor, also called metal oxide chemoresistive gas sensor, may be the most interesting type because of its low cost, high stability, and easy integration with electronics. Research on MOS gas sensors has been conducted for more than 50 years [6]. In 1962, Seiyama demonstrated that a ZnO thin film can quickly change its resistance at 485 °C [7]. A simple chemoresistive device had 100 times higher response to propane compared with that of thermal conductivity detector in gas chromatography at that time. Shaver activated the SnO$_2$ surface with an ultrathin Pt layer and found that the sensor responded quickly to hydrogen [8]. When activated with Pt, metal oxides, such as MoO$_3$, Cr$_2$O$_3$, TiO$_2$, and NiO, exhibit rapid resistance changes to airborne hydrogen at 300 °C as well. Since then, the sensitivity and selectivity of MOS gas sensor have been improved significantly by doping the metal oxides with other catalytic metals, and many new metal oxides have also been tested as gas-sensing materials.

All of the metal oxides used in MOS gas sensors can be divided into n-type or p-type depending on their charge carrier type. Typical n-type metal oxides are SnO$_2$, ZnO, TiO$_2$, WO$_3$, In$_2$O$_3$, and Fe$_2$O$_3$, while typical p-type metal oxides are CuO, NiO, Co$_3$O$_4$, and Cr$_2$O$_3$. ZnO is usually sensitive to NO$_2$ and C$_2$H$_5$OH, whereas CuO is often sensitive to H$_2$S. Metal oxide surfaces are terminated by oxygen species in air, and the core shell structures are formed. Oxygen molecules on the surface of metal oxides gain electrons from the metal oxides and form oxygen ions. The metal oxide surfaces have a hole accumulation layer for the p-type and electron depletion layer for the n-type. P-type metal oxides have a parallel resistance of core and shell layers, while the n-type metal oxides have a series resistance, as shown in Table 3 and Figure 2. When reductive gases are introduced, the thickness of the electron-depletion layer decreases. Thus, the resistance of n-type metal oxide gas sensor decreases. By contrast, the resistance of p-type metal oxide gas sensor increases because of the decrease in the hole accumulation layer.

Table 3. Comparison of properties between p-type and n-type metal oxides [9].

<table>
<thead>
<tr>
<th>Properties</th>
<th>p-type</th>
<th>n-type</th>
</tr>
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<tbody>
<tr>
<td>Core</td>
<td>Insulating (High resistance)</td>
<td>Semiconductor (Low resistance)</td>
</tr>
<tr>
<td>Surface layer</td>
<td>Hole accumulation layer (Low resistance)</td>
<td></td>
</tr>
<tr>
<td></td>
<td>Electron depletion layer (High resistance)</td>
<td></td>
</tr>
<tr>
<td>Total Resistance $R_{\text{total}}$</td>
<td>$R_{\text{total}} = 1/(1/R_{\text{core}} + 1/R_{\text{shell}})$</td>
<td>$R_{\text{total}} = R_{\text{core}} + R_{\text{shell}}$</td>
</tr>
</tbody>
</table>
N-type metal oxide gas sensors have higher response to test gas than p-type metal oxide gas sensors and thus have attracted more attention than the latter [9,10]. SnO₂ and ZnO are the two n-type metal oxide materials that have been extensively studied. SnO₂ was used in the first commercial semiconductor-type gas sensor (Figaro TGS [Taguchi Gas sensor]), which was invented by Naoyoshi Taguchi and used as a sensor for domestic gas leak detector [11]. The gas-sensing element in Figaro TGS 813 is sketched in Figure 3. It is composed of three parts located on a substrate, namely, heater, electrodes, and metal oxide. These three parts are present in nearly all MOS gas sensors.

*Figure 2. Core shell formation and electric current paths after oxygen ions formed on surface of metal oxides [9].*
SnO$_2$ can be synthesized through the following steps. First, Sn of high purity is dissolved in acid; then an alkaline solution is added to precipitate Sn hydroxide. Finally, the precipitate is calcinated at 1200 °C to obtain SnO$_2$ powder. Next, the powder is used as a paste to be painted on a ceramic sen-
sensor element with electrodes, as shown in Figure 4. A binder is added to the paste material, which is then sintered in a furnace to produce a gas sensor.

The main disadvantages of SnO\(_2\) Taguchi type gas sensors are as follows: the sensors have poor selectivity to reductive gases, have poor unit-to-unit consistency of performance, are highly dependent on operation temperature and humidity, require long time before working stably, and consume high power.

Considering these disadvantages of SnO\(_2\) nanoparticle gas sensors, 1-D SnO\(_2\) nanorods (NRs) were later applied in gas sensors to improve the performance of the gas sensors. In 2002, single-crystalline SnO\(_2\) nanobelts were synthesized by chemical vapor deposition (CVD) technique and employed in the gas sensors. The sensors were sensitive to ppb level of NO\(_2\) [13,14]. Subsequently, SnO\(_2\) NRs were grown by hydrothermal method and employed as ethanol sensor [15–17]. However, the hydrothermal growth experiments were carried out at temperatures equal or higher than 180 °C. Thus, autoclaves were necessary for the experiments.

ZnO is much easier to process than SnO\(_2\) and has a high level of versatility in terms of morphology. Therefore, ZnO can be an alternative to SnO\(_2\) in MOS gas sensors and overcome the disadvantages of SnO\(_2\). Hexagonal wurtzite is the most stable crystal type of ZnO at ambient conditions, as shown in Figure 5. The lattice constants of wurtzite ZnO are \(a = 3.296\, \text{Å}\) and \(c = 5.206\, \text{Å}\). ZnO has a wide band gap (3.37 eV) [18]. Oxygen vacancy is the most common defect in ZnO [19,20], and its n-type conductivity comes mainly from the defect.

![Figure 5. Wurtzite structure of ZnO [21].](image)

Meanwhile, 1-D ZnO nanostructures are the most interesting among all the morphologies because of their unique physical properties [18, 22]. However, many previous works on growing 1-D ZnO nanostructures are focused on
CVD technique [23]. CVD requires extremely high temperature and cannot be easily scaled up. The easiest way to obtain 1-D ZnO is by hydrothermal method [24]. An arbitrary substrate with ZnO seed layer can be put into a bottle filled with equimolar Zn(NO$_3$)$_2$ and (CH$_2$)$_6$N$_4$ (hexamethylenetetramine; HMTA) and kept at 90 °C for a few hours; ZnO NRs then start to grow uniformly on the substrate [25]. The mechanism of the chemical reactions is described as follows [26]:

$$\text{(CH}_2\text{)}_6\text{N}_4 + 6\text{H}_2\text{O} \leftrightarrow 6\text{HCHO} + 4\text{NH}_3 \quad (1)$$

$$\text{NH}_3 + \text{H}_2\text{O} \leftrightarrow \text{NH}_4^+ + \text{OH}^- \quad (2)$$

$$\text{Zn}^{2+} + 4\text{NH}_3 \leftrightarrow [\text{Zn(NH}_3)_4]^{2+} \quad (3)$$

$$\text{Zn}^{2+} + 2\text{OH}^- \leftrightarrow \text{Zn(OH)}_2 \quad (4)$$

$$\text{Zn(OH)}_2 \leftrightarrow \text{ZnO} + \text{H}_2\text{O} \quad (5)$$

HMTA acts mainly as a weak base and pH buffer during NR growth [27, 28]. NH$_3$ is a product of the decomposition of HMTA. It plays two roles in the growth process. First, it provides a basic environment for the formation of Zn(OH)$_2$. Second, it forms a coordination complex with Zn$^{2+}$ and stabilizes the Zn$^{2+}$. As a result, ZnO NRs will be formed slowly in the aqueous solution.

In this study, an ultrathin seed layer of Zn on a silicon or glass substrate is made by sputtering for the ZnO nanostructures to grow on. The Zn layer is naturally oxidized into a ZnO layer before the solution growth of NRs [29]. The obtained ZnO NRs or nanowires (NWs) are all of hexagonal type. The morphologies of the 1-D ZnO nanostructures can be tuned by adjusting the growth parameters, specifically, precursor concentration, growth temperature, growth time, and growth pressure. As discussed in [30], the easiest way to grow thin ZnO NWs is by lowering precursor concentration, which should be $\leq 0.005$ M to achieve ultrathin secondary NWs. Growth temperature should be $\geq 90$ °C, and the time should be sufficiently long, usually longer than 16 h. The growth pressure can be kept at atmospheric condition.

Figure 6 shows the ZnO NWs grown on the Zn seed layer on silicon substrates. Notably, Figure 6D shows that the ZnO NWs are grown with site selectivity. This growth can be realized by microfabrication technique, which will be discussed in the experimental part.
1.3. Sensing mechanisms of 1-D ZnO

With the combination of the hydrothermal growth and microfabrication, ZnO NRs or NWs can be grown on zinc seed layer with good control. The sensing mechanisms of 1-D ZnO nanostructures must be addressed first to comprehend the sensing behavior.

1-D ZnO surface is usually terminated with oxygen species in air [31], as shown in Figure 7.
The types of oxygen species adsorbed are determined by the environmental temperature. When measurement temperature is larger than 300 °C, O$_2^-$ is the dominating ion [32].

1. O$_2$ (g) $\rightarrow$ O$_2$ (ads) (Physical adsorption)
2. e$^-+O_2$ (ads) $\rightarrow$ O$_2^-$ (Ionic adsorption; < 100 °C)
3. 2e$^-+O_2^-$ $\rightarrow$ 2O$^-$ (Ionic adsorption; 100-300 °C)
4. e$^-+O^-$ $\rightarrow$ O$_2^-$ (Ionic adsorption; > 300 °C)

After ionic adsorption of the oxygen species, the electrons originating from donor sites (for example, intrinsic oxygen vacancies) are extracted from the conduction band and trapped at the surface of the ZnO NR. These processes produce electron-depleted surface region, which is the so-called surface charge layer with thickness W, as shown in Figure 8. Notably, the negative surface charge results in the surface band bending, which generates a surface potential barrier $eV_{surface}$. The height of this barrier and depth of the band bending depend on the amount and type of the adsorbed oxygen ions.

![Figure 8. Schematic diagram of band bending after chemisorption of charged species (in this case, O$^-$) EC, EV, and EF denote the energy of the conduction band, valence band, and the Fermi level, respectively, while W denotes the thickness of the space-charge layer, and $eV_{surface}$ denotes the potential barrier (adopted from [33]). The conducting electrons are represented by e$^-$ and + represents the donor sites.](image)

Here the thickness of the surface charge layer can be expressed as

$$W = \sqrt{\frac{2\varepsilon_F \varepsilon_0 V_S}{qnb}} \quad (6)$$
where $\varepsilon_r$ is the relative permittivity of the metal oxide, $\varepsilon_0$ is the dielectric constant of vacuum and equals to $8.85 \times 10^{-12}$ F/m, $V_S$ is the band bending, $q$ is the elementary electron charge and equals to $1.6 \times 10^{-19}$ C, and $n_b$ is the charge carrier density [34].

Considering some typical values of ZnO reported from the literature, $n_b$ is approximately $5 \times 10^{17}$ cm$^{-3}$ [35], $\varepsilon_r$ about 8 [20], and $qV_S$ about 0.5 eV [36], $W$ can be estimated to be about 30 nm. When the diameter of ZnO NWs is equal to or smaller than 2$W$, the adsorption and desorption of oxygen will influence the entire ZnO NWs. As a result, the ZnO NWs will be highly sensitive to target gases.

Increase in the thickness of the surface charge layer can lead to a small conduction channel and thus contribute to the large resistance of ZnO NRs. When oxidizing gases are adsorbed onto the surface of the ZnO NRs, they attract more electrons from the surface. The thickness of surface charge layer increases. Thus, the resistance of the ZnO NRs increases. When reducing gases are present, they react with O$^-$ and release electrons to the surface charge layer. Thus, the resistance of ZnO NRs decreases.

The surface charge layer thickness $W$ depends on the Debye length $L_D$, which is a characteristic parameter of semiconductor materials for a particular charge carrier density [33]. In this context, the Debye length can be expressed by Equation (6) [37]:

\[ L_D = \sqrt{\frac{\varepsilon_r \varepsilon_0 k_B T}{q^2 n_b}} \]  

(7)

where $k_B$ is the Boltzmann constant and equals to $1.38 \times 10^{-23}$ J/K. As shown in Equation (7), $L_D$ is temperature dependent. Considering some typical values of ZnO from reported literature, $n_b$ and $\varepsilon_r$ of the value mentioned above, the typical Debye Length is approximately 8 nm at $T$ of about 673 K.

The comparison of Equations (6) and (7) shows that the surface charge layer thickness of the ZnO NR can be expressed in Equation (8).

\[ W = L_D \sqrt{\frac{2qV_S}{k_B T}} \]  

(8)
However, in this thesis, the sensing materials are mostly ZnO NR networks, which possess multiple junctions instead of a single standalone ZnO NR. Thus, a contact barrier exists between the two ZnO NRs, as shown in Figure 9. In this case, both the contact barriers (band bending) and surface charge layers of the ZnO NRs can influence gas sensing. The surface charge layer also affects band bending.

Figure 9. Structural and band model showing the role of contact regions of ZnO NRs in determining the conductance over the layer of ZnO NRs (adapted from [33])

Three cases can happen depending on the diameter (D) of ZnO NRs and the thickness of the surface charge layer [37].

If D is significantly larger than 2W, the surface charge layer has little effect on the resistance of ZnO NRs. However, the surface charge layer significantly influences the contact barrier. Gas sensing is controlled by the contact barrier between the two ZnO NRs. Moreover, the contact barrier is independent from the diameter of the ZnO NRs. The sensitivities of the ZnO NRs are not influenced by their diameters. In this case, the layer conductance of the ZnO NR network can be described by Equation (9) [24,36].

\[
G = G_0 \exp \left( - \frac{qV_s}{kT} \right) \quad (9)
\]

If D is slightly larger than 2W, the surface charge layer affects the resistance of ZnO NRs and contact barrier between the ZnO NRs. Thus, gas sensing depends on both the contact barriers and sizes of the ZnO NRs.
If D is equal to or smaller than 2W, only the surface charge layer affects the resistances of the ZnO NWs [38]. Our works in Papers II–IV focus on the influence of the geometry of 1-D ZnO nanostructures on their gas-sensing performance.

In addition to the abovementioned geometry, the surface defects of ZnO NRs can also affect gas sensing. For example, the response of ZnO NWs to NO2 is linearly proportional to the number of oxygen-vacancy-related defects [39]. NO2 molecules tend to interact with Zn atoms when oxygen vacancy exists nearby [40, 41]. The oxygen vacancy facilitates the adsorption of NO2 on the ZnO surface, as shown in Figure 10. Furthermore, an increased amount of oxygen vacancies near the surface introduces more electrons near the surface. The reaction between electrons and NO2 subsequently occur at a fast rate. Given that the surface to volume ratio increases substantially as the diameter of ZnO NRs decreases to nanoscale, the number of surface defects increases.

The four most common defects in ZnO are oxygen vacancy, zinc vacancy, interstitial oxygen, and interstitial zinc [42]. The defect chemistry of ZnO under the annealing condition has been studied [43, 44]. However, the way by which the defect chemistry influences the gas sensing has not been reported before. Our work in Paper V attempts to address this issue.

![Figure 10. Oxygen vacancies near the surface of ZnO NR facilitate the adsorption of NO2 gas.](image)

ZnO usually shows a significantly higher response to oxidized gases than to reductive gases because of its n-type semiconductor nature. Doping with noble metals can facilitate the adsorption of reductive gases on ZnO NRs through the spillover effect. For instance, Pd nanoparticles (NPs) on the surfaces of the ZnO NRs can interact with hydrogen molecule and facilitate the dissociation of molecules into hydrogen atoms. The hydrogen atoms are spilled over onto the ZnO NRs and change the resistances of the ZnO NRs, as shown in Figure 11. Many works have been done to investigate the low-temperature hydrogen-sensing properties of ZnO-Pd systems [45–48]. PdHx formation can even significantly enhance the sensitivity of ZnO–Pd systems to hydrogen at room temperature [46]. However, the hydrogen-sensing property of ZnO–Pd systems at temperature higher than 350 °C has not been studied. This condition has been investigated in our latest work in Paper VI, and the sensing mechanism has been discussed.
In summary, ZnO NRs as the gas-sensing material function as receptors and transducers [49]. The receptor function is related to gas adsorption process. This function can be influenced remarkably by surface defects and noble metal doping. The transducer function refers to the conversion of the reception of target gas into resistance changes. This function can be influenced by the surface charge layer and contact barrier and is mostly determined by the geometry of ZnO NRs.

1.4 Motivation

Previous works on 1-D ZnO nanostructure gas sensors have been conducted mainly through synthesis-transfer route, that is, synthesizing ZnO NWs or NRs first and then transferring them onto the electrodes to make the gas sensor [50–52]. The process is time-consuming, and deviation between batches is high. Our route is to first fabricate electrodes of the gas sensor and then grow ZnO NRs or NWs on-chip by hydrothermal method.

The first four papers focus on investigating the influence of the geometry of 1-D ZnO on its gas sensing. Paper I describes how sub-20 nm ZnO NWs can be grown on silicon substrate. Several important growth parameters are investigated thoroughly. Paper II reports the route to fabricate NO$_2$ gas sensor based on on-chip hydrothermally grown ZnO NRs on glass. Paper III compares the NO$_2$-sensing performances of three gas sensors with different diameters and 1-D ZnO nanostructures of different densities. Paper IV compares the ethanol-sensing performances of three different ZnO morphologies, including the NRs by a hydrothermal method, NWs by a CVD route, as well as NPs by a thermal deposition method.

The final two papers investigate the impact of defects and metal doping on the ZnO gas sensor. Paper V compares the NO$_2$-sensing performances of the ZnO NRs under three different annealing temperatures and discusses the mechanisms of the different sensing performances on the basis of the defect
theory. Paper VI studies ZnO NRs with three different thickness of palladium by sputtering. The three different samples are compared. The origin of different sensing performance is examined.

In summary, investigations of both the transducer and receptor function of 1-D ZnO in gas sensors have been carried out in this thesis. Special efforts have been focused on the evaluation of important factors that determine the sensitivity, selectivity, and stability of the 1-D ZnO gas sensors.
2. Experimental

2.1 Fabrication of gas sensor devices

The ZnO gas sensors are fabricated through the combination of microfabrication and hydrothermal method. MOS gas sensors usually have three components, that is, heater, electrode, and metal oxide. The normal route is to make the electrodes first, and then transfer the metal-oxide material onto the electrodes, and finally, integrate the heater. In this study, electrodes and the heater can be made simultaneously through microfabrication. A Zn seed layer in the form of small islands is deposited on and between the electrodes for later hydrothermal growth. The ZnO nanostructures were obtained through on-chip growth instead of transferring. This route can improve the reliability of the gas sensing and decrease unit-to-unit deviation. Furthermore, the cost of the gas sensors can be decreased through batch production.

2.1.1 Microfabrication

Microfabrication technique usually has four categories: patterning, deposition, removal, and bonding. Patterning is usually performed through photolithography, in which a UV lamp is used as light source. The process is shown in Figure 12.
Photoresist is a UV-sensitive polymer. After UV exposure through a mask and development, the photoresist forms a pattern. The patterned photoresist covers a specific area of the substrate, which is not affected by the next deposition or etching step. A photoresist can withstand most acidic conditions, such as HF, HCl, and H₃PO₄. However, it is dissolved by a strong base solution, such as KOH.

Deposition adds a new layer of a material onto the substrate. Physical vapor deposition (PVD) and CVD are the commonly used deposition techniques.

PVD is a process in which the source material goes from a solid or liquid phase to a vapor phase and then reaches the substrate, where the source material condenses to form a thin film [53]. The two most common PVD processes are sputtering and evaporation.

Sputtering is a process whereby surface atoms are ejected from a solid source material, called target, because of the bombardment of the target by energetic particles, normally argon gas ions [54]. The process is shown in Figure 13.
Evaporation is a PVD process in which a hot source material evaporates and then reaches the substrate with little or no collision with gas molecules in the space between the source and substrate [54]. The heat element can be either resistance or electron-beam, depending on the melting point of the source material. Platinum, for example, has a high melting point of 1768.2 °C; therefore, an electron beam should be used. The equipment is shown in the schematic diagram in Figure 14.

The evaporation process requires considerably higher vacuum than the sputtering process. In our projects, sputtering and evaporation are both used for depositing metal layers. Notably, sputtering can also be used to sputter metal oxides. After sputtering, the wafer with metal on photoresist is lifted off in

Figure 13. Schematic diagram of sputter [55].

Figure 14. Schematic diagram of evaporation deposition [56].
three acetone baths and one isopropanol bath sequentially. The procedure is therefore called a lift-off process.

The thickness and roughness of the deposited film is important to semiconductor devices. Stylus profilometry and atomic force microscopy (AFM) are the common tools used to examine thin films. In Paper I, AFM is used to examine the roughness and thickness of the Zn seed layer. Stylus profilometry is used in all the other works to check the thickness of the electrode layer.

Microfabrication can build patterns of electrodes and a seed layer before the on-chip hydrothermal growth of 1-D ZnO nanostructures. A typical flow chart is shown in Figure 15. The sensor electrodes were patterned by lithography, sputter deposition, and lift-off of 100-nm Pt on 10-nm Cr layers on a glass substrate. The seed islands of 15 nm-thick Zn on a 10-nm silicon layer were then deposited on and between the electrodes using the same techniques (three bottom panels on the left).

Figure 15. Process flow for device fabrication (top panels) and micrographs of a fabricated device (bottom panels).
2.1.2 Growth of 1-D ZnO nanostructures

After patterning, the chip is put upside down in a premixed equimolar solution of Zn(NO₃)₂ and HMTA and kept there for a few hours. 1-D ZnO nanostructures with different diameters and densities can be obtained by adjusting growth parameters, such as precursor concentration, temperature, pressure, and time. ZnO NR networks can be obtained from a two-step growth process using a precursor at a relatively high concentration, whereas a ZnO NW network is obtained also from a two-step growth process with precursor at low concentration. The growth temperature influences the aspect ratio of the ZnO nanostructures. The higher the temperature is, the larger the aspect ratio is. The ZnO nanostructures are usually grown at temperatures higher than 80 °C. The growth time influences the length of ZnO nanostructures. It is usually longer than 16 h. Considering that the concentration of the precursor will be extremely low after 16 h in the first step; the second step is needed to develop the secondary NWs or NRs long enough to contact each other. All of the growth experiments are carried out at atmospheric pressure without autoclave.

2.2. Characterization of ZnO Nanostructures

Seven measurement techniques have been applied to examine the ZnO nanostructures. Optical microscopy can examine the electrodes of the gas sensors and the overall density of the ZnO nanostructures. Scanning electron microscopy (SEM) can examine the morphologies of the ZnO nanostructures. Energy-dispersive X-ray spectroscopy in SEM can examine the element information of the ZnO nanostructures as well. Transmission electron microscopy (TEM) examines the distribution and the crystal type of PdO NPs on the ZnO NRs. X-ray diffraction (XRD) examines the crystal type of the ZnO nanostructures. Photoluminescence spectroscopy has been applied to examine the defects near the surface of ZnO NRs. X-ray photoelectron spectroscopy (XPS) has been applied to examine the surface chemical information of ZnO-Pd systems. The basic principles of these techniques are provided below.

2.2.1 Optical Microscopy

After hydrothermal growth, the gas sensor must be examined under an optical microscope, which has limited resolution (half of the light wavelength, 200 nm) because of the visible light source. Despite this limitation, optical microscope can be conveniently used to determine whether the gas sensor works or not. The electrodes of the gas sensor must be intact. The ZnO NRs or NWs between the electrodes have to be connected to each other to form
an electrical path. Bright mode and dark mode were combined to obtain more information of our samples.

### 2.2.2 SEM with EDS

Considering that the diameters of our nanomaterial are typically less than 300 nm, SEM is an indispensable tool to characterize our ZnO nanostructures. In SEM, an electron beam scans over the surface of the sample and yields an image of the surface of the sample. The resolution is approximately 10 nm. Figure 16 shows the interaction volume between the specimen and incidence electron beam. SEM images are usually formed based on secondary electrons, which are surface sensitive. In addition, element analysis can be done locally using an EDS detector. The analysis volume of EDS in SEM is large, and the depth ranges from 0.1 to 3 microns, depending on the acceleration voltage. SEM requires the specimen to be conductive. Thus, the ZnO samples must be sputtered with a thin Pd–Au layer to increase the conductivities of the samples. The gas-sensing performances of the ZnO nanostructures are measured first before SEM, because the sputtered Pd–Au layer alters or terminates the sensing performance of the sensor. SEM has been used in all of the studies presented in this work to examine the morphologies of the ZnO nanostructures. EDS has been used in Paper VI to compare Pd-doped ZnO NR sample with the non-doped one in a quantitative manner.

![Figure 16. Interaction volumes between incidence electron beam and bulk specimen in SEM [57].](image-url)
2.2.2 TEM

Generally, SEM is used for the examination of bulk material, whereas TEM for thin specimen. Interaction between the incidence electron beam and thin specimen is shown in Figure 17 [58].

![Interaction volume between incidence electron beam and thin specimen in TEM](image)

*Figure 17. Interaction volume between incidence electron beam and thin specimen in TEM [58].*

Three types of transmitted electrons are commonly used in TEM to obtain information on the specimen. The functions of the three types of electrons are listed below [58].

- **Unscattered electrons:** Incident electrons are transmitted through the specimen without any interaction. The transmission is inversely proportional to the thickness. A thick area will appear dark, whereas a thin area will have more transmitted electrons and thus will appear light.

- **Elastically scattered electrons:** Incidence electrons are scattered by atoms in the specimen without energy loss. They can yield information about the orientation, atomic arrangements, and phase present in the area being examined.

- **Inelastically scattered electrons:** Incidence electrons interact with atoms and lose energy during the interaction. They can be used to extract both compositional and bonding information on the examined specimen region.

2.2.3 XRD

XRD can be used to analyze the crystallography information of ZnO. The basic principle is based on Bragg’s law:
where \( d \) is the spacing between diffracting planes, \( \Theta \) is the incident angle, \( n \) is any integral, and \( \lambda \) is the wavelength of the beam [59]. In our experiment, Cu K\(_\alpha\) radiation was used, and \( \lambda \) is 1.54184Å. According to Bragg’s Law, the spacing between diffracting planes can be determined if the incident angle is known. Different crystal plane of the grown ZnO nanostructures can be determined. XRD has been used in most of the papers in this thesis. For ZnO NWs grown on silicon substrate in Paper I, Grazing Incidence XRD has been used to minimize the signal from the underlying silicon substrate and obtain more information on ZnO NWs.

2.2.4 Photoluminescence (PL)

PL is a nondestructive technique for the detection of defects in semiconductors. Both shallow-level and deep-level defects can be detected, provided that the recombination between the deep-level defects is radiative [60]. However, the PL signal is highly sensitive to surface defect recombination.

The following are the five of the most commonly observed PL transitions: 1) band-to-band recombination (Figure 18a), 2) excitonic recombination (Figure 18b), 3) bound exciton (BE) recombination (Figure 18c), 4) free electron recombine with a hole on a neutral acceptor (Figure 18d), and 5) donor–acceptor (D–A) recombination (Figure 18e). A detailed description can be found in [60]. Light emission from the recombination reveals the defect types in the examined bulk material. ZnO may have several types of defects (i.e., vacancy and interstitial of oxygen and zinc) near the surface. Thus, PL is an important tool to probe the surface defects states, as discussed in Paper V.

![Figure 18. Radiative transitions observed with PL [60].](image)

\[2dsin\theta = n\lambda\]
2.2.5 XPS

X-ray Photoelectron Spectroscopy (XPS) was first known as ESCA (Electron Spectroscopy for Chemical Analysis) [61]. It is a powerful tool to investigate chemical information from material surface at a depth of 10 nm. The element type, the chemical states of the element, and the quantity of the element in the surface region can all be obtained from XPS spectra. The surface analysis by XPS is accomplished by irradiating a sample with monochromatic soft X-rays, and then analyzing the energy of the detected photoelectrons [62]. In our works, Al Kα X-ray with energy of 1486.7 eV is used. The measured kinetic energy of the emitted electron is given by

\[ E_{\text{kinetic}} = E_{\text{photon}} - (E_{\text{binding}} + \Phi) \]

where \( E_{\text{photon}} \) is the energy of the X-ray photon, \( E_{\text{binding}} \) is the binding energy of the electron, and \( \Phi \) the spectrometer work function [62].

In Paper VI, XPS is used to investigate the amounts and chemical states of sputtered Pd film on ZnO NRs.

2.3 Gas sensing characterization

The gas sensors are tested with flow-through technique [63]. Switching between dry air and test gas takes approximately 1 s. In the experiment, the standard gas is mixed with dry air as carrier. This process uses several mass flow controllers, as shown in Figure 19. The standard gas is composed of the target gas balanced with pure nitrogen. The concentration of the standard gas is usually 1% or 1000 ppm. The flow rates of the standard gas and dry air are varied, and test gases with low concentrations are obtained. Before the sensing measurement, dry air flows through the sensing chamber until a stable sensor resistance is obtained. The resistance of the sensors is continuously measured by using a Keithley SourceMeter (Model 2700) and sampled using a computer. The dry air and the test gas are switched on and off each cycle.
Two different measurement systems are used in the projects: one automatic measurement system for NO$_2$ gas, the other is a semi-automatic measurement system for reductive gas (hydrogen, ammonia, and ethanol). Before the automatic measurement of NO$_2$ gas, a test run is performed to determine the response and recovery period at the low concentration. The value is then inputted in the measurement program. The program for NO$_2$ test automatically switches the test gases or dry air on and off according to the input time, while the dynamic resistances of the sensor are recorded continuously. For reductive gas, a test run is also required to determine response and recovery period. However, switching the gases on and off is performed manually while the program continuously acquires the resistance data. Therefore, the response and recovery time is more accurate at low concentrations of test gas than at high concentrations. The reason is that the latter requires longer time than the former. The automatic program does not wait longer than the input time for switching.

The sensors are placed on a heater chuck during the gas measurement, even though the heaters are integrated on the sensor chip. Two reasons can explain this condition. On the one hand, the external heater is more stable and uniform than the heater on the chip, given that a thermal drop occurs on the chip when the heater on the chip is used. On the other hand, the external heater facilitates the comparison of different sensors at the same operation temperature. All of the measurements are carried out with the external heater.
The ZnO sensors are tested at temperature higher than 200 °C considering the adsorption barrier of test gases and humidity. Most of the measurements are performed at temperatures of 350, 400, and 450 °C. The influence of humidity is negligible.

In this thesis, the sensor response is defined as $R_{\text{gas}}/R_{\text{air}}$ or $R_{\text{gas}}/R_{\text{air}}$. $R_{\text{air}}$ is the resistance of the sensor in the dry air, and $R_{\text{gas}}$ is the resistance of the sensor when the test gas is introduced. Response time is defined as the time required to arrive 90% of full response from the base line to the saturated response. Accordingly, recovery time is also defined as the time required to arrive 90% of decrease from the saturated response to the base line, as shown in Figure 20.

![Figure 20. Dynamic resistance changes of ZnO NWs during one measurement cycle, concentration of NO$_2$ gas is 2.5 ppm.](image)

Sensitivity in this thesis is defined as response divided by the concentration of the test gas. Given that different studies may measure the same gas at different concentrations, sensitivity can be used to compare the sensor performances. Notably, in several publications, including Paper II in this study, sensitivity is defined in the same way as response, and this definition is misleading. Selectivity is defined as the ratio between the responses of the sensor to two different gases at same concentration and measurement conditions.

$$\text{Selectivity} = \frac{\text{Response}_1}{\text{Response}_2}.$$
3. Summary of results

3.1 Summary of Paper I

Paper I describes the method to synthesize ultrathin secondary ZnO NWs on silicon substrate. In the first step, an ultrathin Zn layer is deposited on the substrate. This active metal is oxidized to ZnO before hydrothermal growth of NWs. In the second step, ultrathin ZnO NWs are grown at 90 °C for 16 h or longer using 0.005-M precursor solution of Zn(NO$_3$)$_2$ and HMTA. Low temperature and atmospheric pressure growth make the method promising for batch production of ZnO NWs. The mechanism of the growth of ultrathin ZnO NWs is illustrated in Figure 21. Ultrathin ZnO NWs is formed through three steps. First, a dense layer of ZnO NRs is formed on the thin ZnO seed layer. Second, sharp tips and secondary seeds are formed. Third, ultrathin secondary NWs grow from the tips of the primary ZnO NRs. Notably, the ultrathin secondary ZnO NWs can site-selectively grow on silicon substrates using isolated islands of Zn seed layer.

![Figure 21](image)

Figure 21. Proposed mechanism for the growth of ultrathin ZnO NWs from formation of big ZnO NRs from seed layer to nucleation and growth of secondary ultrathin ZnO NWs from the tips of the NRs [29].
3.2 Summary of Paper II

NO$_2$ sensors based on ZnO nanostructures are built on a glass substrate. As shown in Figure 22, ZnO NRs are connected to one another in the two steps. In the first step, short NRs grow on the seed sites after 4 h. In the second step, long NRs grow continuously from short NRs. After the two steps, NRs are sufficiently long to make contact with each other, as shown in Figures 22D and 23B. The NRs are quite porous, and this condition is good for gas sensing, as shown in Figure 23C. The measurements show that the ZnO NR gas sensors performed best at 450 °C. Moreover, the sensors are more sensitive to NO2 than the other reductive gases.

*Figure 22. Formation of ZnO NRs junctions by two-step hydrothermal growth: (A) deposition of Pt electrodes; (B) deposition of Zn seed islands; (C) growth of dense ZnO nanorods (first step); (D) growth of long porous ZnO nanorods (second step) [63].*
Figure 23. Material characterizations of ZnO NRs synthesized with hydrothermal method at 85 °C: (A) SEM image of ZnO NRs within Pt electrodes, (B) higher magnification of ZnO NRs grown from different islands making NR junctions, (C) image of a single ZnO NR, (D) X-ray diffraction of the ZnO NRs [63].

3.3 Summary of Paper III

In Paper II, on-chip grown ZnO NRs show good response to NO₂. Nevertheless, the sensitivity is not as high as those reported by other works on similar ZnO nanostructures. In the present case, sensitivity is used to compare our work with others. In Paper III, a comparative study of three ZnO 1-D nanostructures is conducted. ZnO NWs with high sensitivity to NO₂ are synthesized by on-chip hydrothermal method.

The three ZnO nanostructures are ZnO NRs, dense ZnO NWs, and sparse ZnO NWs. They have different geometries and densities, although they have the same crystal type. The diameters of the ZnO NRs range from 150 nm to 200 nm, as shown in Figure 24A. Dense ZnO NWs have a diameter of approximately 25 nm to 50 nm, as shown in Figure 24B. The diameters of sparse ZnO NWs are less than 25 nm.
Figure 24. SEM images of the three ZnO nanostructures: (A) ZnO-NRs, (B) dense ZnO NWs, and (C) sparse ZnO NWs. The scale bar is 1 μm. The insets are magnifications of the respective images with scale bar of 100 nm.

The highest sensitivity of ZnO NWs is nearly 6 per ppm, as shown in Table 4. This value is significantly higher than those of ZnO nanoarrays synthesized at 95 °C. Moreover, the ZnO NWs have comparable sensitivity with those of ZnO nanostructures synthesized at temperature higher than 100 °C.

Table 4. Comparison of the best sensing performances of the three ZnO samples to 2.5 ppm NO₂.

<table>
<thead>
<tr>
<th>Sample</th>
<th>Optimum work Temperature (°C)</th>
<th>Response time (s)</th>
<th>Recovery time (s)</th>
<th>Response</th>
</tr>
</thead>
<tbody>
<tr>
<td>ZnO-NRs</td>
<td>350</td>
<td>226</td>
<td>264</td>
<td>1.96</td>
</tr>
<tr>
<td>Dense ZnO NWs</td>
<td>350</td>
<td>113</td>
<td>169</td>
<td>4.1</td>
</tr>
<tr>
<td>Sparse ZnO NWs</td>
<td>300</td>
<td>52</td>
<td>101</td>
<td>14.92</td>
</tr>
</tbody>
</table>

3.4 Summary of Paper IV

In Paper IV, three ZnO nanostructures with different morphologies are tested toward ethanol. ZnO NRs are grown by on-chip hydrothermal method on a thermally oxidized silicon chip. ZnO NWs are prepared by on-chip chemical vapor deposition method, while the ZnO NPs through the thermal deposition of sheet-like hydrozincite at 400 °C. As shown in Figure 25B, ZnO NRs each have a diameter of approximately 250 nm. ZnO NWs each have a width of around 80 nm, as shown in Figure 25D. ZnO NPs have an average size of about 30 nm, as shown in Figure 25F.
Among the three ZnO nanostructures, ZnO NPs had the highest responses, as shown in Figure 26D.
3.5 Summary of Paper V

In Paper V, on-chip hydrothermally grown ZnO NRs are annealed at either at 400, 500, or 600 °C. The crystal structures and defect emissions of ZnO NRs before and after each annealing are examined by XRD and PL Spectroscopy. No evident change in crystal structure is observed. However, defect emissions are considerably changed. Three peaks are examined in PL (Figure 27). The peak centered at 380 nm is related to exciton recombination in ZnO surface. The peak centered at 550 nm corresponds to the recombination of electrons in the conduction band with oxygen vacancy. The peak centered at 610 nm is referred to interstitial oxygen defects.

When annealing temperature increases from 400 °C to 600 °C, the number of oxygen vacancies decreases and that of interstitial oxygen increases near the ZnO surface.
Unannealed ZnO NRs show the highest response among all the samples, but the sample is not stable. In addition, it is annealed while being measured so that the result is not repeatable. ZnO NRs_400 °C exhibits the highest response to NO₂ among the three annealed samples, as shown in Figure 28. However, ZnO NRs_400 °C is unstable after 1 week in air (Figure 29). ZnO NRs_600 °C show low response to NO₂ but demonstrate high stability after 1 week in air.

Figure 27. PL of ZnO NRs before and after annealing.

Figure 28. Response of the ZnO NRs to NO₂ at different temperatures: (A) unannealed, (B) annealed at 400 °C, (C) annealed at 500 °C, (D) annealed at 600 °C.
Figure 29. Response of the ZnO NRs to 10 ppm NO$_2$ in 10 cycles measured at 350 °C: (A) ZnO at 400 °C, (B) ZnO at 600 °C.

The different sensing properties of ZnO NRs annealed at different temperatures are due to defects reactions as shown below [43]:

\[
\begin{align*}
1/2O_2 + 2e^- &= O^{2-}, \\
1/2O_2 + V_O &= O_O, \\
1/2O_2 &= O_O + V_{Zn}, \\
1/2O_2 + Zn_i &= O_O + Zn_{Zn}, \\
1/2O_2 &= O_i,
\end{align*}
\]

where $O_O$ and $Zn_{Zn}$ refer to the neutrally charged oxygen and zinc at the crystal lattice site. Oxygen diffusion in the ZnO NRs can eliminate $V_O$ and $Zn_i$, as shown in Equations (10) and (12), and it can also increase $V_{Zn}$ and $O_i$, as shown in Equations (11) and (13), respectively.

3.6 Summary of Paper VI

In this work, 2, 4, and 8 nm-thick Pd layers are sputtered on the on-chip hydrothermally grown ZnO NRs to improve hydrogen sensing at high temperature. Before the gas test, the ZnO NRs are annealed at 650 °C, and the Pd is oxidized into PdO. The crystal direction of PdO cluster is <101> (Figure 30F).
Figure 30. SEM images of ZnO NRs: (A) overall image of the on-chip grown ZnO NRs, (B) ZnO NRs without Pd, (C) ZnO NRs with 4 nm Pd, and (D) ZnO NRs with 8 nm Pd. HRTEM images of the ZnO-Pd 4 nm sample: (E) low magnification, and (F) high magnification

Pristine ZnO has low response to hydrogen, as depicted in Figure 31E. ZnO-Pd 2 nm sample has the highest response to hydrogen at 450 °C. The response of the 2 nm ZnO-Pd sample to 1,000-ppm hydrogen is 8.23 (Figure 30F). The response of ZnO-Pd 2 nm to hydrogen increases with measurement temperature. By contrast, the response of ZnO-Pd 4 nm to hydrogen with measurement temperature tends to decrease. The response increases as the temperature decreases from 450 °C to 350 °C, and the highest value is 6 (Figure 31G). The ZnO-Pd 8 nm exhibits a sensing behavior opposite to those of the other three. The resistance of the sample increases as hydrogen is introduced, as shown in Figure 31D.
The mechanisms underlying the different sensing behaviors are explained by the spillover effect and Pd–Zn alloy formation at high temperatures. Pd–Zn alloy formation enhances the spillover effect but decreases the amount of ZnO. The ZnO-Pd 2 nm exhibits low spillover effect on hydrogen at 350 °C. At high temperatures, the number of Pd reduced from the PdO is increased in ZnO-Pd 2 nm sample, to ensure that the spillover effect is enhanced. The Pd–Zn alloy is formed and thus consumes a part of the ZnO NRs. However, owing to the small amount of Pd, the ZnO consumption does not result in any large negative effect on sensing performance. The ZnO-Pd 4 nm sample exhibits high spillover effect at 350 °C because of the sufficient amounts of Pd. However, at 450 °C, the amount of Pd–Zn alloys increases at the cost of the ZnO material. As a result, the response decreases at increasing temperature. When the Pd layer is extremely thick, as in the case of the ZnO-Pd 8 nm sample; it forms a large amount of Pd–Zn alloy in the ZnO NRs at high temperatures. The base resistance of the sensor decreases two orders of magnitude relative to that of undecorated ZnO (Figure 31D). In this case, Pd forms a continuous layer between the electrodes in ZnO-Pd 8 nm sensor. Therefore, the ZnO-Pd 8 nm exhibits reverse and low response compared with the other ZnO-Pd samples.
Figure 32. Sensing mechanism of the ZnO NR-Pd sensors at high temperature.
Conclusion and outlook

The studies in this thesis explored the transducer function and receptor function of 1-D ZnO in gas sensors. On the basis of all the results presented thus far, the following conclusions can be drawn: 1) Ultrathin secondary ZnO NRs can be hydrothermally grown on silicon substrate at times longer than 16 h at 90 °C using 0.005-M precursor solution of Zn(NO$_3$)$_2$ and HMTA. 2) Two-step grown ZnO NRs have good sensitivity and selectivity to NO$_2$. 3) Sparse ZnO NWs have the highest sensitivity to NO$_2$ among all the hydrothermally grown 1-D ZnO samples. 4) ZnO NPs possess high sensitivity to ethanol because of its small size and large surface area; 5) Annealing in air influences oxygen vacancy near the surface of ZnO NRs, thus affecting the sensitivity and stability of ZnO NRs. 6) Pd-Zn alloy formed at high temperatures has harmful effects on the gas sensing performances of ZnO NRs. Therefore, the thickness of sputter-deposited Pd should be optimized.

Gas sensors based on on-chip hydrothermally grown 1-D ZnO nanostructures have been fabricated, decorated, tested, and stabilized. Nevertheless, many other studies may be carried out in future work. The following are examples of these studies:

1) Different ZnO morphologies can be obtained by on-chip hydrothermal growth. The growth of crystal is determined by the surface energy of each crystal plane. Through the addition of some specific surfactant, some crystal planes of ZnO can be inhabited during solution growth. Selectivity for the reductive gases, such as ethanol or ammonia, can be enhanced when the crystal plane are well controlled during the hydrothermal growth.

2) Oxygen vacancy at the surface should be controlled to increase stability. The best approach is to add another surface layer to remove oxygen from ZnO and stabilize the oxygen vacancy at the interface. If an nm-thick Al$_2$O$_3$ can be deposited on the surface of ZnO NWs with conformity, both the sensitivity and stability of ZnO NWs should be increased.

3) Combination of ZnO nanostructures and catalytic metals are of great interest for selective gas sensing. Some common catalytic metals are Cu, Ni, Pd, and Pt. More exotic system should be explored to enhance not only gas response and but also selectivity at high temperatures.
4) ZnO NWs based on room-temperature sensor is interesting. When the diameter of ZnO NWs decreases, their surface volume ratio increases, and defects near the surface per volume unit increases as well. Given that oxygen defects on the surface increases the reactive sites for NO₂, ZnO may be used to sense NO₂ at room temperature. Nevertheless, humidity is expected to have a significant influence on ZnO gas sensing at room temperature.


Normalt finns det en blandning av olika gaser i luften. Man kan tänka sig att använda olika sensorer för att mäta olika gaser. Problemet är att det inte finns någon sensor som reagerar enbart på en gas och är helt okänslig för de besläktade gaserna. Övervakning och mätning av en gasblandning är ett komplicerat arbete, som kräver inte bara sensorer, utan också ett sofistikerat dataprogram för att kunna känna igen och mäta mängden av de enskilda gaserna.

Det finns olika mätprinciper för att bestämma gaser. Man kan använda sig av en kvartskristall som mäter akustisk vågförändring, en så kallad fälteffekttransistor för att mäta förändring av ström genom en katalytisk metall,
en infrarödsensor för att mäta förändring av IR-ljuset, eller en metalloxid för att mäta förändring av resistansen i det. Förändringarna som mätts är resultat av interaktion mellan en gas och sensorelementen. Man översätter sedan förändringarna till koncentration av den uppmätta gasen.

Denna avhandling undersöker olika nanostrukturer av zinkoxid (ZnO) som sensormaterial. Med nanostrukturer menas pelare, fiber och partiklar med dimensioner från några till hundratal nanometer.


Vidare undersökningar koncentrerades på design och tillverkning av mikrosensorer. Eftersom vattenånga alltid finns i luften och biter sig snabbt fast vid alla ytor, inklusive sensormaterialytan, konkurrerar den bort gasen som ska mätas. Därför ska ett värmeelement inkluderas på mikrochippet för att få bort vattenånga och för att aktivera halvledarmalet ZnO. Värmeelementet ska placeras så nära sensormaterialet som möjligt. Ett par elektroder ska också ligga inom det uppvärmda området för att mäta resistansförändring av sensormaterialet. Hela sensorn kan krympas på en yta av 0,5x0,5 millimeter av ett glassubstrat. Liten storlek är viktig för att hålla energiförbrukningen låg och för att kunna integrera sensorn i en elektronisk krets i framtiden.

Mätningarna visar att nanostrukturer med mindre diameter är känsligare mot gaser än de med större diameters och ZnO-nanomaterialet som tillverkas med hydrotermiska metoden är särskilt känslig mot kvävedioxid. Eftersom ZnO-nanomaterialet också reagerar mot andra gaser om än något sämre än
mot kvävedioxid, gjordes olika försök av modifiering av materialet. Ett av dessa försök var att ”dekorera” nanomaterialet med nanopartiklar av palladium (Pd). Det visar sig att palladium har en katalytisk effekt som gör att ZnO-materialet blir känsligare mot vätgas. Även vid hög temperatur som vid tillverkning av vätgas, kan sensorn vara lämplig för övervakning av vätgasläckage vid tillverkning av den explosiva gasen. Metoden för palladiumdekoration var sputtering, liknar sprejning, av palladium atomer på sensorchip. Med denna metod kan mängden av palladium atomer kontrolleras. Experiment visar också att palladium mängden på ZnO nanomaterialet måste optimeras för att få den bästa känsligheten av ZnO nanomaterialet mot vätgas.

Ovan nämnda undersökningar har sammanfattats i denna avhandling, men mycket arbete återstår. Några ytterligare undersökningar är att fortsätta med materialmodifiering, förbättra design för att få ner effekten för uppvärmning till tiotal eller till några få milliwatt, integrera ett antal sensorer på ett och samma chip för multigasmätning, och testa mot utandningsgas för att upptäcka eventuella sjukdomar. Ambitionen är att åstadkomma ett sensorsystem som är så litet och konsumerar så lite ström att det går att kunna integrera i bärbara apparater som mobiltelefoner. Ett sådant sensorsystem lär kunna bidra till att höja säkerhet och livskvalitet för oss alla.
Finally, it comes to the end of this thesis, as well as the end of my PhD studies. I feel happy at last since I do learn a lot from this project. Back to four years ago, I came to Hugo’s office and asked him if he would like to be my supervisor. I told him that I studied chemistry before and I thought the morphology of ZnO nanostructures may be tuned through chemical route. Hugo seemed to be happy about my background. Then my four year work on ZnO nanorod gas sensors started. Thank Hugo for your support and trust. Thank you for leading me into this interesting subject! Thank you for always keeping your door open! Thank you for help with my stay in Uppsala! You are not only my supervisor, but also one of my best friends in Uppsala.

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最後我要感谢我的家人。感谢父母！没有您们，我也不会走到今天。谢谢爸爸，我知道您希望我去美国，瑞典是我的选择，谢谢您尊重我的决定！谢谢妈妈，我知道您心里希望我多在您身边陪您。可是您还是支持我，希望我追求自己的想法！谢谢岳父岳母帮我照顾玉嵘和瑞雪！谢谢老婆，给我生了这么健康可爱的女儿！谢谢玉嵘的支持和理解，希望以后我们一家人幸福的生活！

Now I become much stronger because I have you all around me! I will carry on after this PhD journey. I wish you all happiness and prosperity in the future!

Mingzhi Jiao
Ångstrom Laboratoriet
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A doctoral dissertation from the Faculty of Science and Technology, Uppsala University, is usually a summary of a number of papers. A few copies of the complete dissertation are kept at major Swedish research libraries, while the summary alone is distributed internationally through the series Digital Comprehensive Summaries of Uppsala Dissertations from the Faculty of Science and Technology. (Prior to January, 2005, the series was published under the title “Comprehensive Summaries of Uppsala Dissertations from the Faculty of Science and Technology”.)